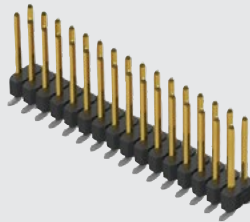




(2.54 mm) .100"

TSM-116-02-S-DV-LC



TSM-121-01-T-SV



SMT .025" SQ POST HEADER

Board Mates:

SSW, SSQ, SSM, BSW, ESW,
ESQ, BCS, SLW, CES, HLE

Cable Mates:

IDSS, IDSD

SPECIFICATIONS

For complete specifications
and recommended PCB layouts
see www.samtec.com?TSM

Insulator Material:

Black Liquid Crystal Polymer

Terminal Material:

Phosphor Bronze

Plating:

Au or Sn over

50 μ" (1.27 μm) Ni

Operating Temp Range:

-55 °C to +105 °C with Tin;

-55 °C to +125 °C with Gold

Voltage Rating:

475 VAC -SV/-DV mated with

BCS or SSM

RoHS Compliant: Yes

MATES	CURRENT RATING (PER PIN)
TSM/SSW	4.7 A
TSM/SSM	5.4 A
TSM/HLE	4.1 A
2 PINS POWERED	

PROCESSING

Lead-Free Solderable: Yes

-DH/-SH Lead Coplanarity:

(0.15 mm) .006" max (02-36)*

-DV/-SV Lead Coplanarity:

(0.10 mm) .004" max (02-05)

(0.13 mm) .005" max (06-10)*

(0.15 mm) .006" max (11-36)*

*(.004" stencil solution

may be available; contact

IPG@samtec.com)

RECOGNITIONS

For complete scope
of recognitions see
www.samtec.com/quality

FILE NO. E111594

ALSO AVAILABLE (MOQ Required)

- Edge Mount and Locking Clips for -SV
- Solder Locks for -DH and Shrouds for -DV
- Other platings

Note:

Some lengths, styles and
options are non-standard,
non-returnable.

TSM	1	NO. PINS PER ROW	LEAD STYLE	PLATING OPTION	ROW OPTION
		02 thru 36	-01 = .230" (5.84 mm) Post Height (Mates with SSW, BCS, SSM, IDSS, IDSD)	-F = Gold flash on post, Matte Tin on tail	
			-02 = .320" (8.13 mm) Post Height (Mates with SSM -DH)	-L = 10 μ" (0.25 μm) Gold on post, Matte Tin on tail	
			-03 = .420" (10.67 mm) Post Height (For Bottom Mount & Pass Through)	-S = 30 μ" (0.76 μm) Gold on post, Matte Tin on tail	
			-04 = .120" (3.05 mm) Post Height (Mates with SLW, CES, HLE)	-T = Matte Tin	

APPLICATIONS

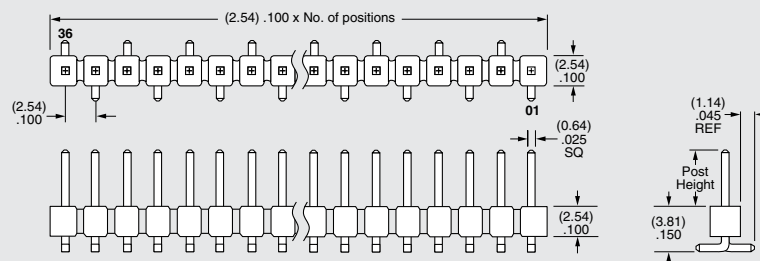


HIGH-SPEED CHANNEL PERFORMANCE

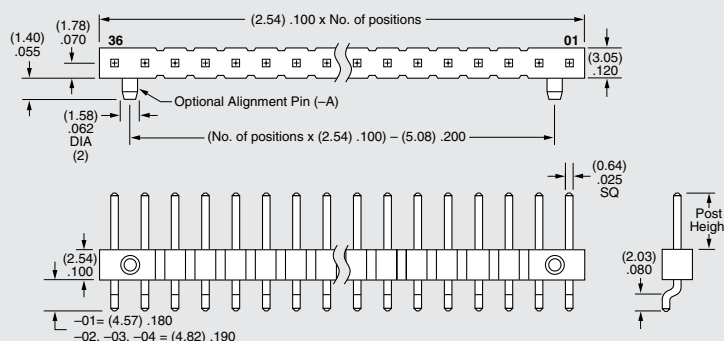
Rating based on Samtec reference
channel. For full SI performance data
visit Samtec.com or contact
SI@samtec.com8
G b p s

-SV

= Single Row Vertical Pin



-SH

= Single Row
Horizontal Pin

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM

All parts within this catalog are built to Samtec's specifications.

Customer specific requirements must be approved by Samtec and identified in a Samtec customer-specific drawing to apply.



TSM-126-02-L-DH-K

TSM-115-01-T-SH-A



TSM-110-01-T-DV



TSM SERIES

OTHER OPTIONS

-A

= Alignment Pin
metal or plastic
at Samtec discretion
(Not available
with -TM or -MT)
(02 positions min.)
(Not available with -LC)

-LC

= Locking Clip
(Not available with -TM)
(3 positions min.)
(Not available with -A)
(Manual placement
required)

-K

= (6.50 mm) .256" DIA
Polyimide Film
Pick & Place Pad
(-SH: 4 positions
minimum without -TR;
2 & 3 positions
available with -TR)
(-DH: 4 positions
minimum
without -TR)

-“XXX”

= Polarized
Position

-P

= Plastic Pick & Place Pad
(-DV: 4 positions minimum
without -TR; 2 & 3 positions
available with -TR)
(-SH: 4 positions
minimum without -TR;
2 & 3 positions
available with -TR)
(-DH: 5 positions
minimum without -TR)
(-SV: 4 positions
minimum without -TR;
2 & 3 positions
available with -TR)



-SV



-SH & -DH

-TR

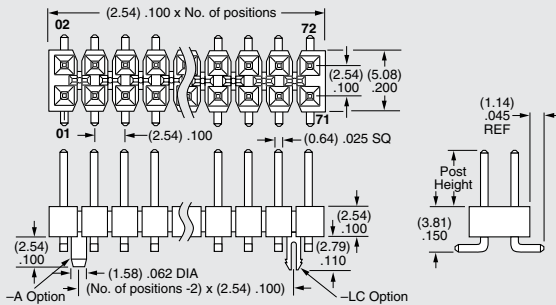
= Tape & Reel Packaging
-SV: 02-22 positions, -DV: 02-28 positions,
-SH: 02-30 positions, -DH: 02-29 positions
(Not available with -MT or -TM)

-FR

= Full Reel Tape & Reel
(must order maximum quantity per reel;
contact Samtec for quantity breaks)
-SV: 02-22 positions, -DV: 02-28 positions,
-SH: 02-30 positions, -DH: 02-29 positions
(Not available with -MT or -TM)

-DV

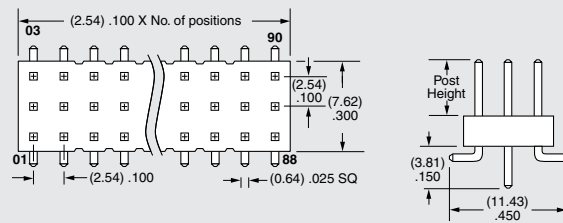
= Double Row Vertical Pin



-TM

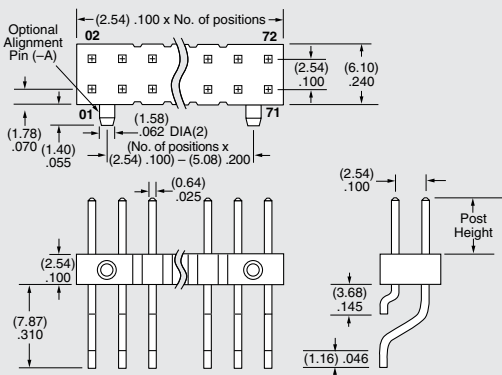
= Triple Row Vertical Mixed Technology (Style -01 only)

02 thru 30 positions only



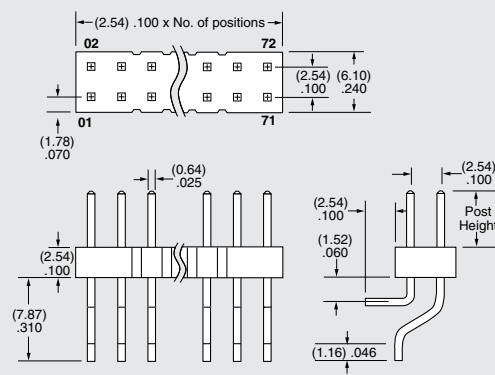
-DH

= Double Row Horizontal Pin
(Style -01, -02 or -03 only)



-MT

= Mixed Technology Pin
(Style -01, -02 or -03 only)



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Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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